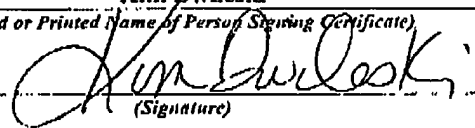


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P. 01

CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8) Applicant(s): <u>Gardecki et al.</u>			Docket No. BUR920030026US1
Application No. 10/604,164	Filing Date 6/28/2003	Examiner Brook Kebede	Group Art Unit 2823
Invention: METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS			
<p>I hereby certify that this _____ <u>Request for Reconsideration (12 pages)</u> _____ <small>(Identify type of correspondence)</small></p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u>)</p> <p>on <u>1/7/2005</u> <small>(Date)</small></p> <div style="text-align: right; margin-top: 50px;"> <p><u>Kim Dwileski</u> <small>(Typed or Printed Name of Person Signing Certificate)</small></p> <p> <small>(Signature)</small></p> </div> <p align="center" style="margin-top: 50px;"> Note: Each paper must have its own certificate of mailing. </p>			

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.: 10/604,164

Applicant(s): Gardecki et al.

Filed.: June 28, 2003

Art Unit: 2823

Dkt. No.: BUR920030026US1

Examiner: Brook Kebede

Title: **METHOD FOR FORMING INTERCONNECTS ON THIN WAFERS**

Honorable Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR RECONSIDERATION

This Request for Reconsideration is being filed in response to the Office Action mailed on November 12, 2004.

BUR9-2003-0026-US1